



Vishay Siliconix

N-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A) ^a	Q _g (Typ)	
20	$0.420 \text{ at V}_{GS} = 4.5 \text{ V}$	0.606		
	0.501 at V _{GS} = 2.5 V	0.505	0.92	
	0.660 at V _{GS} = 1.8 V	0.15		

FEATURES

• TrenchFET® Power MOSFET: 1.8 V Rated

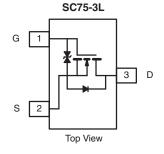
• ESD Protected: 2000 V

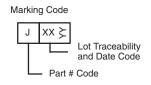


RoHS

APPLICATIONS

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories
- · Battery Operated Systems
- Power Supply Converter Circuits
- Load/Power Switching Cell Phones, Pagers





Ordering Information: Si1046R-T1-E3 (Lead (Pb)-free)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	20	V	
Gate-Source Voltage		V _{GS}	± 8		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	I _D	0.606 ^{b, c}		
Continuous Diain Curient (1) = 130 C)	T _A = 70 °C	טי	0.485 ^{b, c}	Α Α	
Pulsed Drain Current		I _{DM}	2.5	^	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	0.21 ^{b, c}		
Manianum Danier Dissinational	T _A = 25 °C	P _D	0.25 ^{b, c}	W	
Maximum Power Dissipation ^a	T _A = 70 °C	' b	0.16 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Marrian de Ambrianto d	t ≤ 5 sec	R_{thJA}	440	530	°C/W		
Maximum Junction-to-Ambient ^{b, d}	Steady State		540	650	C/VV		

Notes:

- a. Based on $T_C = 25$ °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 sec.
- d. Maximum under steady state conditions is 650 $^{\circ}\text{C/W}.$

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Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Static	,			, ,,	l	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 vA		20.5		1400
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	In = 250 HA		- 2.12		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.35		0.95	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 30	mA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$			1	
		V _{DS} = 20 V, V _{GS} = 0 V, T _J = 85 °C			10	μA
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	2.5			Α
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 0.606 \text{ A}$		0.336	0.420	
		$V_{GS} = 2.5 \text{ V}, I_D = 0.505 \text{ A}$		0.395	0.501	Ω
		V _{GS} = 1.8 V, I _D = 0.150 A		0.438	0.660	1
Forward Transconductance	9 _{fs}	V _{DS} = 10 V, I _D = 0.606 A		2.1		S
Dynamic ^b						
Input Capacitance	C _{iss}			66		pF
Output Capacitance	C _{oss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		17		
Reverse Transfer Capacitance	C _{rss}			7		
Tatal Oata Obarra		$V_{DS} = 10 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 0.606 \text{ A}$		0.99	1.49	
Total Gate Charge	Q_g			0.92	1.38	nC
Gate-Source Charge	Q_{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 0.606 \text{ A}$		0.15		
Gate-Drain Charge	Q _{gd}			0.30		
Gate Resistance	R_{g}	f = 1 MHz		212		Ω
Turn-On Delay Time	t _{d(on)}			17	26	
Rise Time	t _r	$V_{DD} = 10 \text{ V}, R_{L} = 20.8 \Omega$		19	28.5	ns
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 0.48 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		76	114	
Fall Time	t _f			27	41	
Drain-Source Body Diode Characteristic	cs					
Pulse Diode Forward Current ^a	I _{SM}				2.5	Α
Body Diode Voltage	V _{SD}	I _S = 0.48 A		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			16	24	nC
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 1.0 A, di/dt = 100 A/μs		4.8	7.2	
Reverse Recovery Fall Time	t _a			12.3		ns
Reverse Recovery Rise Time	t _b	1		3.7		†

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

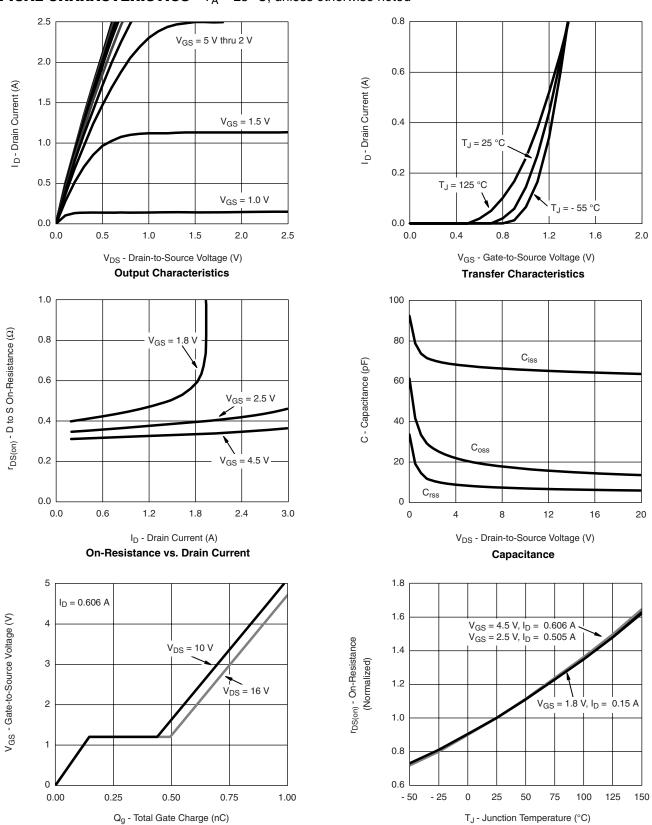
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.



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TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted



Gate Charge

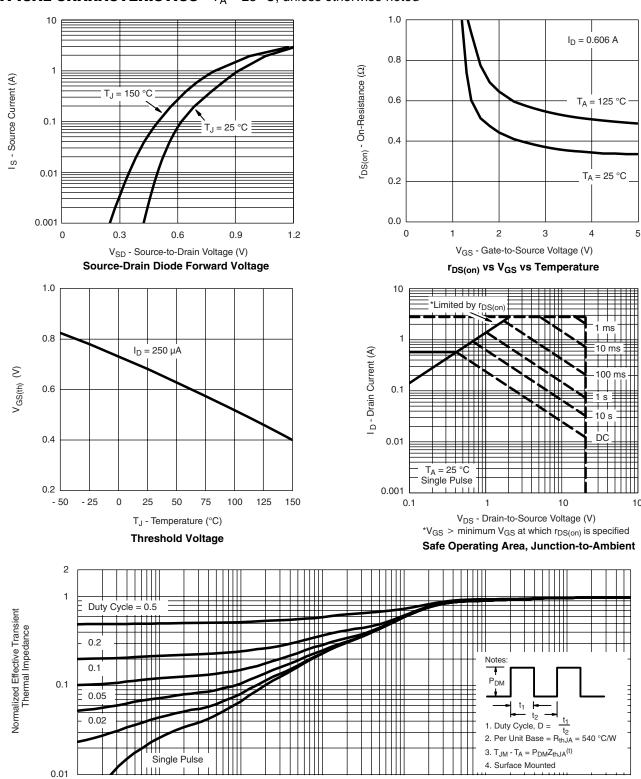
On-Resistance vs. Junction Temperature

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Square Wave Pulse Duration (sec) Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?74595.

10-1

10-4

10-3

10⁻²

600

100

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